Semiconductor Devices

Prof. Eric Polizzi ECE 609- Spring07 University of Massachusetts, Amherst

Syllabus

- Instructor:
- Office:
- Day and Time:
- Place:
- Office Hours:

Prof. Eric Polizzi Marcus 201C

- M-W-F 10:10-11:00am
- Marston 220
- : M-W-F, 11:00-12:00am
- E-mail: polizzi@ecs.umass.edu
 - Homework and important information will be sent by e-mail
- <u>http://www.ecs.umass.edu/ece/polizzi</u>

Syllabus

 Prerequisite: A solid state or quantum mechanics undergraduate course is recommended

Textbook:

J.P. Colinge and C. A. Colinge, "*Physics of Semiconductor Devices*", (Kluwer Academic, Boston, 2002).

On-line ECE-609 spring06 draft lectures notes

Suggested Reading:

- C. Cohen-Tannoudji, B. Diu, and F. Laloe, "Quantum mechanics"
- C. Kittel, "Introduction to Solid State Physics", Fourth Edition (John Wiley and Sons, New York, 1971).
- S. M. Sze, "Semiconductor Devices: Physics and Technology", (John Wiley and Sons, 1985).
- Y. Taur and T. H. Ning, "*Fundamentals of Modern VLSI Devices*", (Cambridge University Press, New York, 1998)

Outline

I. Physics of Semiconductors:

- Review of quantum mechanics
- Energy band theory
- Semiconductors Fundamentals
- Theory of electrical conduction

II. Two-Terminal devices

- P-N junctions
- Metal-semiconductors contacts
- MOS capacitors
- D Heterojunctions

III. Three-Terminal devices

- MOSFET
- Bipolar junction transistor
- IV. Nanoscale semiconductor devices
 - Quantum effects in semiconductors
 - Introduction to quantum transport

Grading

HomeworkMidtermFinal

30% (~6 homework) 30% (on chapters 1-2) 40% (all chapters)

ECE609 Overview



Numerical Modeling and Simulation: ECE614 - Fall 2007

ECE609 Overview

• Purpose of the Course:

- OProvide the foundations to understand what is a semiconductor
- OProvide the foundations to understand the electronic properties and the physics of charge transport in semiconductors
- Explain the operating principles in semiconductor devices

OPerspectives of emerging device technology

History of semiconductor transistors

1947: Bipolar Junction Transistors (BJT)

- high current drive capability, widely used as an amplifier, key component in oscillators, high-speed integrated circuits and switching circuits.
- Device parameters are hard to control, power consumption is extremely high limiting its integration density

1960: Planar Process NMOS technology

Easier control over processing, high circuit integration density, low cost, lesser power dissipation than BJT, NMOS preferred over PMOS due to higher speed

NMOS integrated circuits have large static power consumption

• 1963: CMOS technology (1971: Microprocessor, 1993: Pentium)

- Zow power consumption
- Due to technology scaling, device parameters will eventually reach their physical limitations, majors barriers in further advancement of CMOS technology

 20??: Emerging Nanoelectronics devices: CNT, Si or III-V Nanowire, Molecular devices, SET, Spintronics, etc...